

Excellent Integrated System Limited

Stocking Distributor

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Diodes Incorporated DMN2005DLP4K-7

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>







DMN2005DLP4K

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

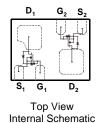
Features

- Ultra Low Profile Package
- Low On-Resistance
- Very Low Gate Threshold Voltage, 0.9V Max.
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN1310-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @





Ordering Information (Note 4)

-		
Part Number	Case	Packaging
DMN2005DLP4K-7	X2-DFN1310-6	3000/Tape & Reel

X2-DFN1310-6

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information

Notes:

DL

DL = Product Type Marking Code





DMN2005DLP4K

Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	20	V
Gate-Source Voltage		V _{GSS}	±10	V
Drain Current per element (Note 5)	Continuous Pulsed (Note 6)	ID	300 350	mA

Thermal Characteristics @TA = 25°C unless otherwise specified

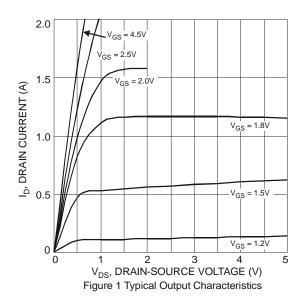
	-]
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	400	mW
Thermal Resistance, Junction to Ambient	$R_{ ext{ heta}JA}$	231	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

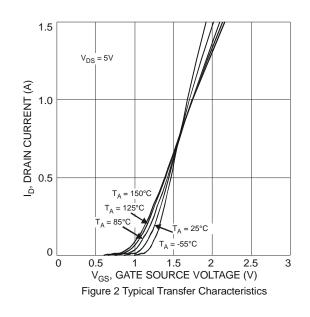
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (per element) (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	20			V	$V_{GS} = 0V, I_D = 100 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	10	μΑ	$V_{DS} = 17V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_		±5	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (per element) (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	0.53		0.9	V	$V_{DS} = V_{GS}, I_D = 100 \mu A$
		_	0.35	1.5		$V_{GS} = 4V$, $I_D = 10mA$
			0.4	1.7		$V_{GS} = 2.7V, I_D = 200mA$
Static Drain-Source On-Resistance	RDS (ON)		0.45	1.7	Ω	$V_{GS} = 2.5V, I_D = 10mA$
			0.55	3.5		V _{GS} = 1.8V, I _D = 200mA
		—	0.65	3.5		$V_{GS} = 1.5V, I_D = 1mA$
Forward Transfer Admittance	Y _{fs}	40			mS	$V_{DS} = 3V, I_{D} = 10mA$

Notes: 5. Device mounted on FR-4 PCB.

6. Pulse width ${\leq}10\mu S,$ Duty Cycle ${\leq}1\%.$ 7. Short duration pulse test used to minimize self-heating effect.

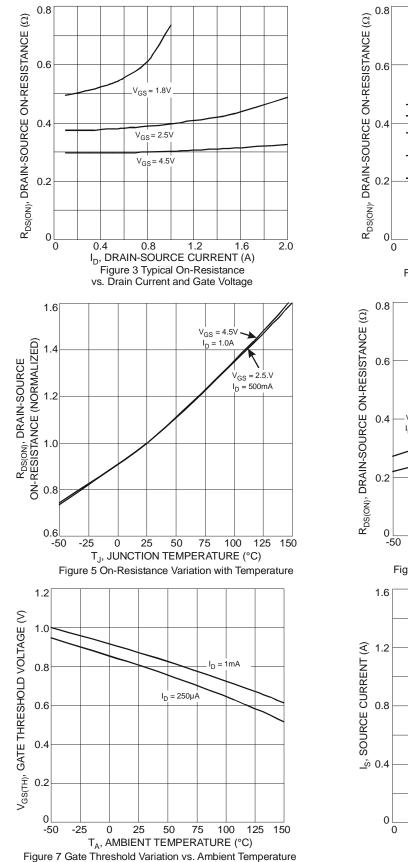


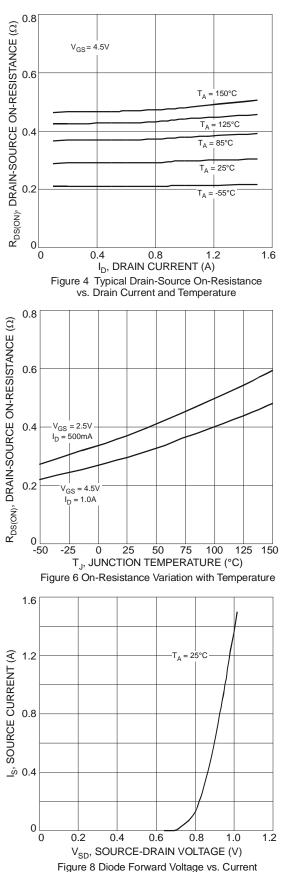






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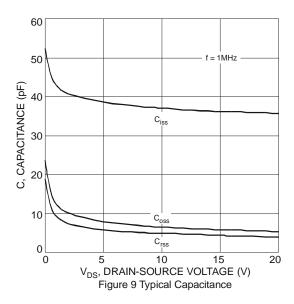


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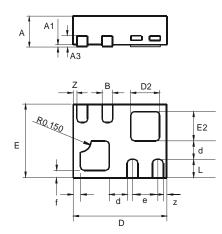




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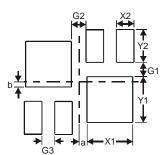


Package Outline Dimensions



X2-DFN1310-6					
Dim	Min	Max	Тур		
Α		0.40			
A1	0	0.05	0.02		
A3			0.13		
b	0.10	0.20	0.15		
D	1.25	1.38	1.30		
d			0.25		
D2	0.30	0.50	0.40		
ш	0.95	1.075	1.00		
e			0.35		
E2	0.30	0.50	0.40		
f			0.10		
L	0.20	0.30	0.25		
Z			0.05		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
G1	0.16
G2	0.17
G3	0.15
X1	0.52
X2	0.20
Y1	0.52
Y2	0.375
а	0.09
b	0.06

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